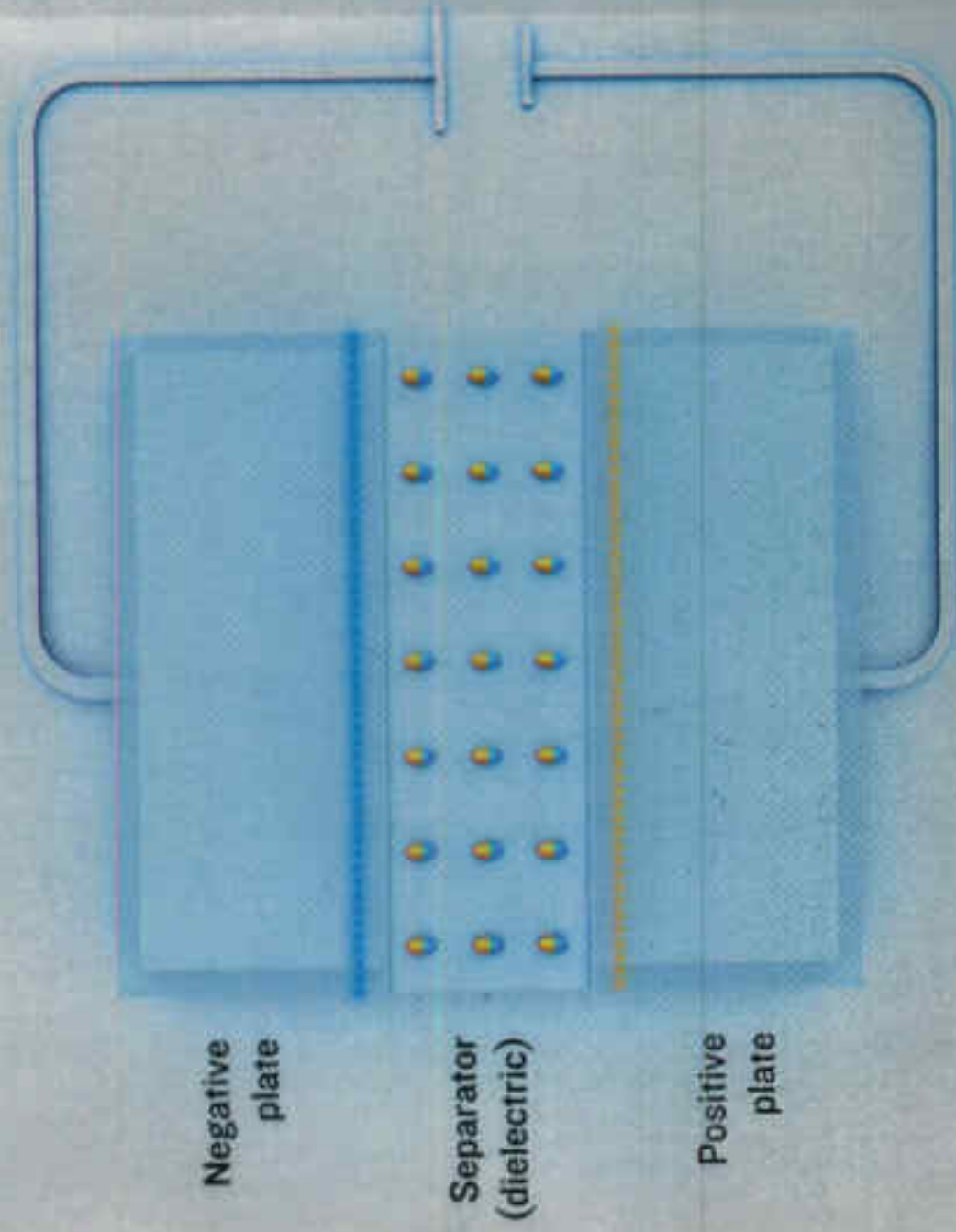
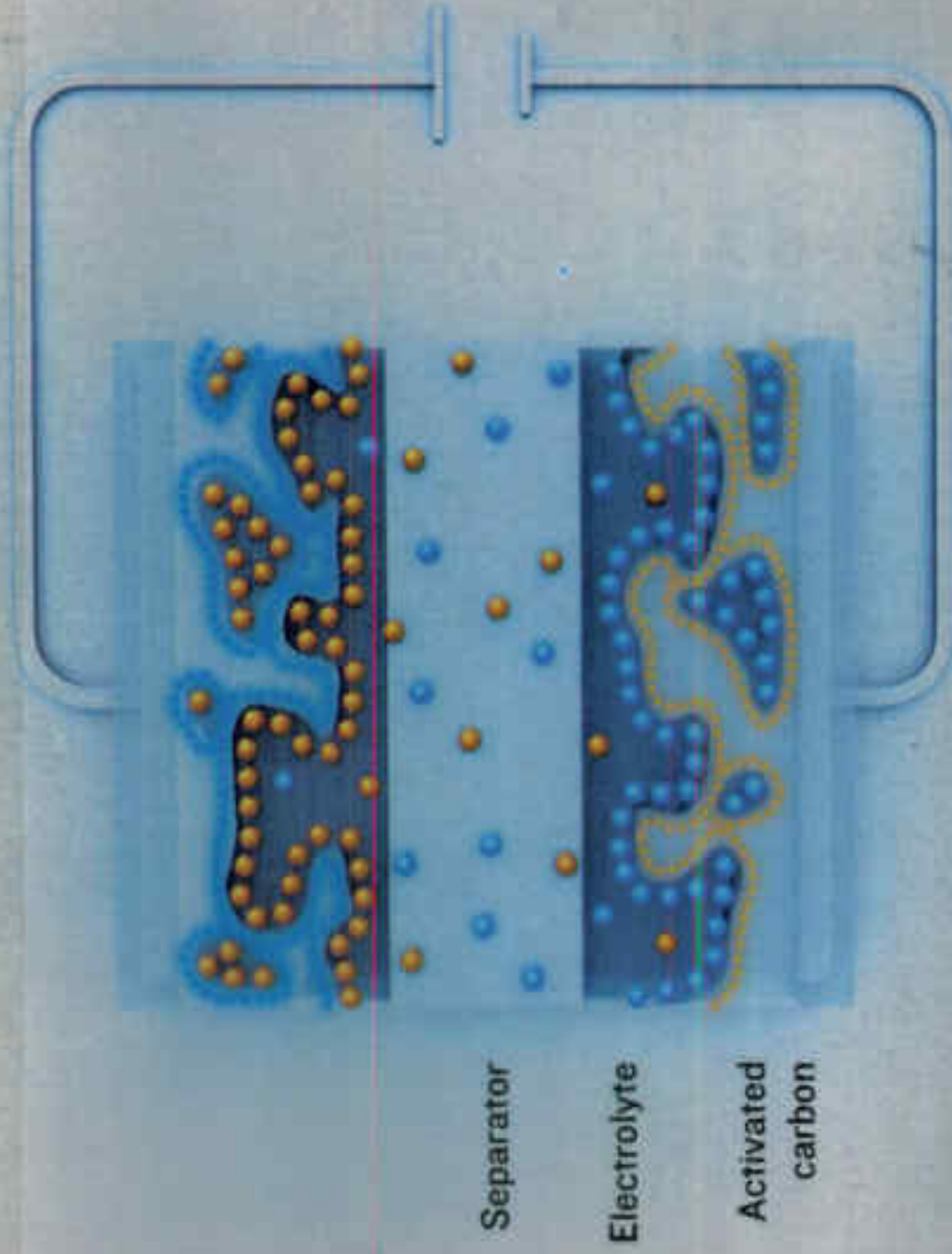


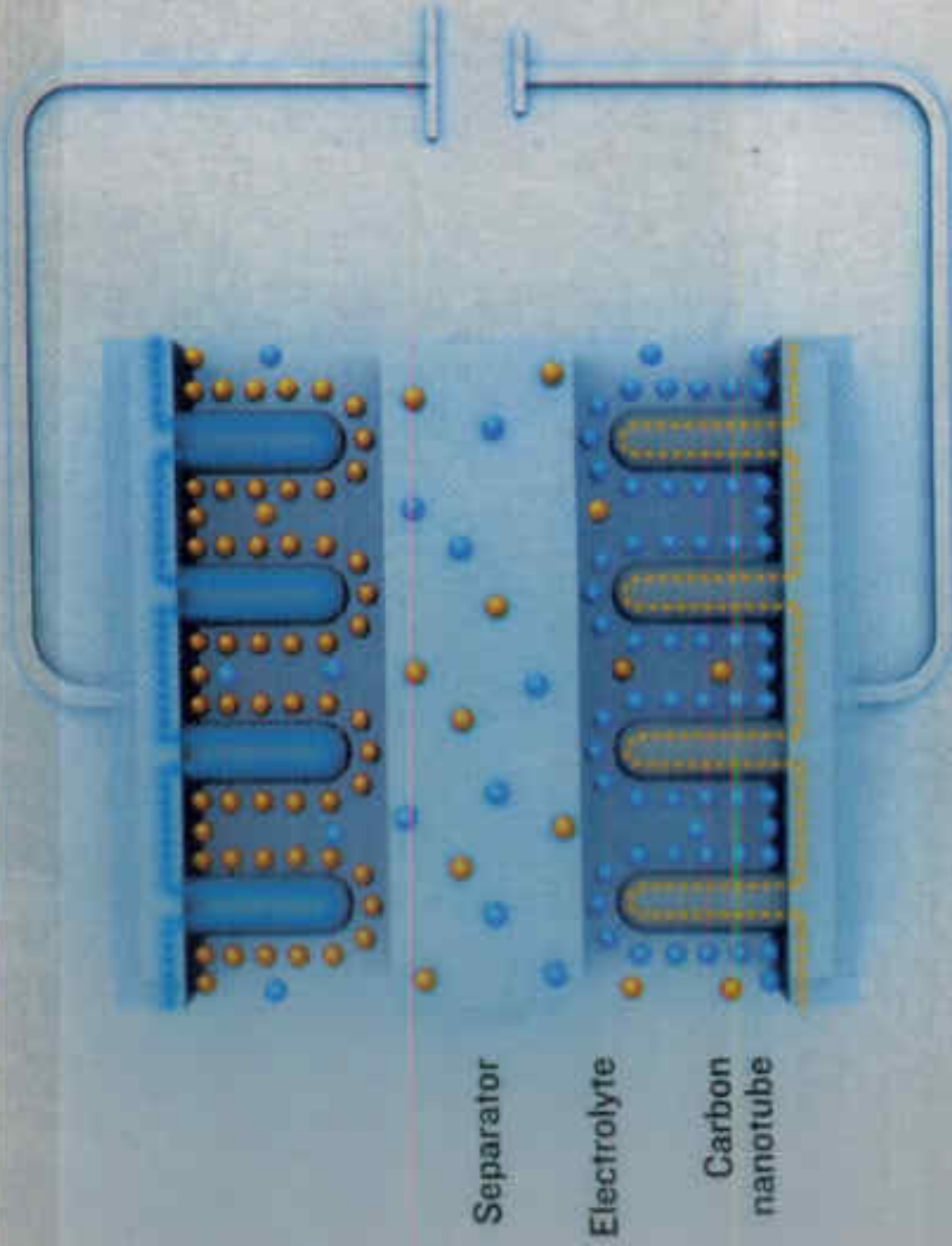
PILING ON THE FARADS



In a typical capacitor, electrons are removed from one plate and deposited on the other. Polarized molecules in the dielectric concentrate the electric field. One major factor determining capacitance is the surface area of the plates.



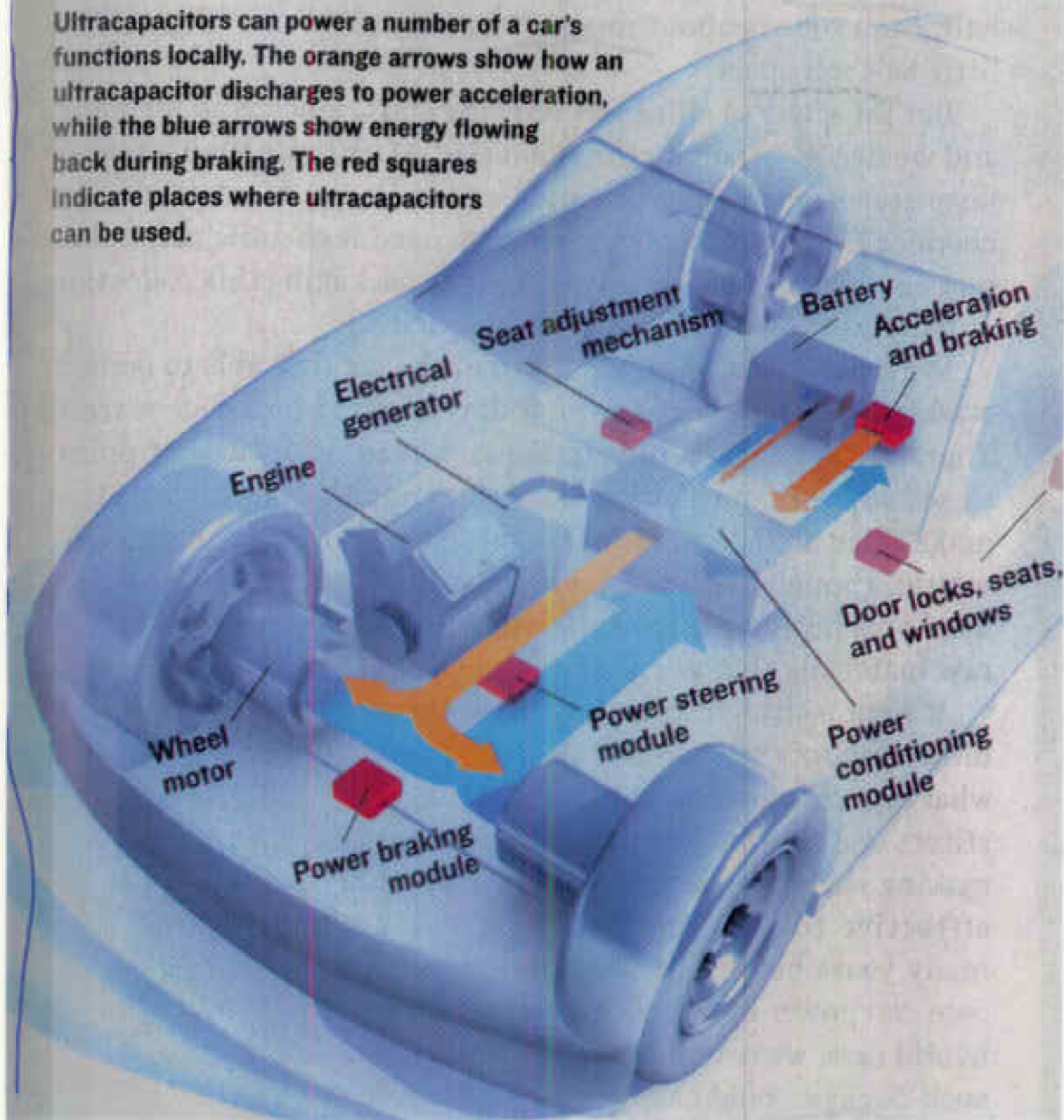
An ultracapacitor can store more charge than a capacitor can, because the activated carbon has a pocked interior, much like a sponge. This means that ions in the electrolyte can cling to more surface area.



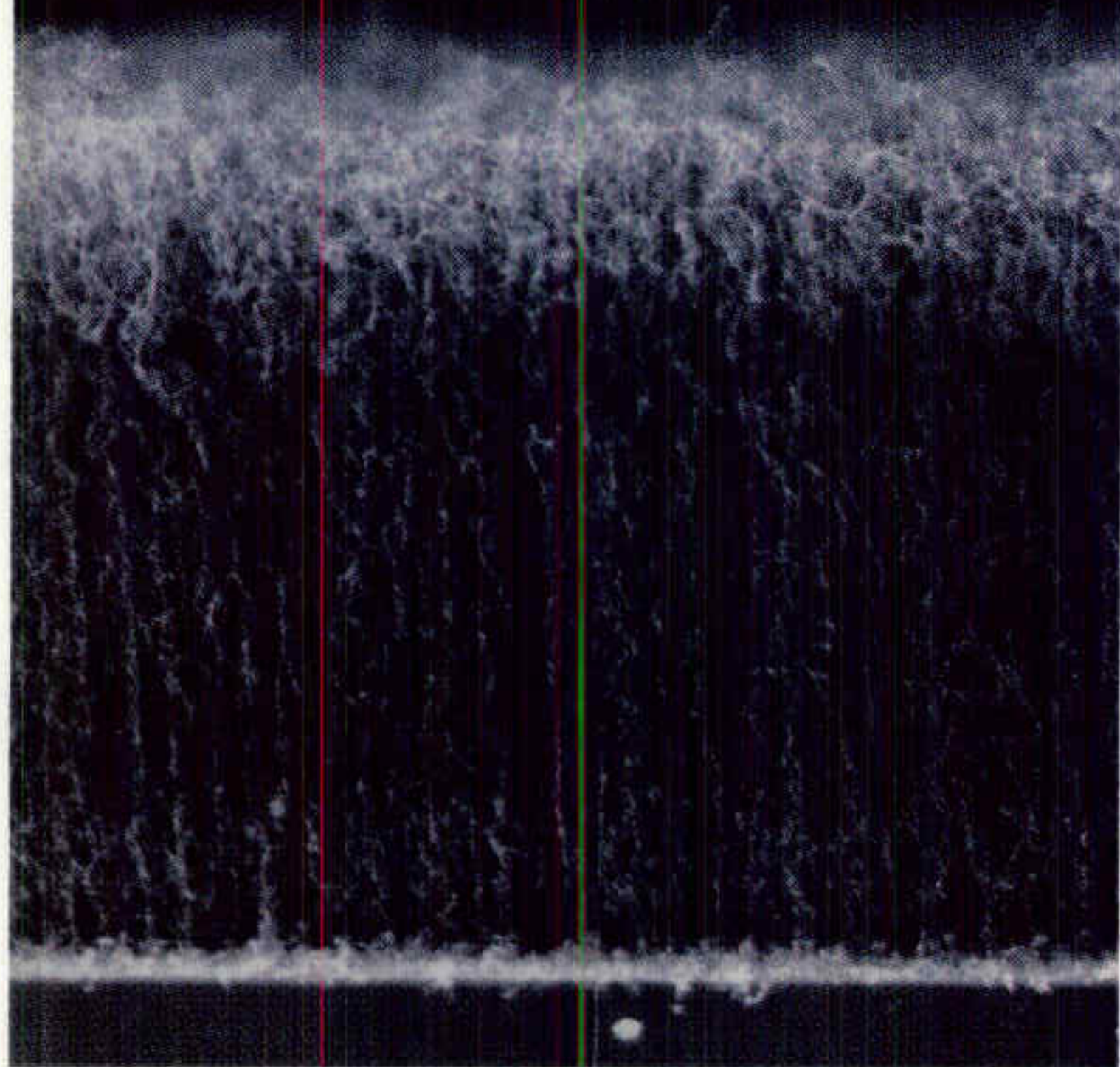
With finer dimensions and more uniform distribution, carbon nanotubes enable greater energy storage in ultracapacitors than activated carbon does.

HOW TO ULTRACAP A CAR

Ultracapacitors can power a number of a car's functions locally. The orange arrows show how an ultracapacitor discharges to power acceleration, while the blue arrows show energy flowing back during braking. The red squares indicate places where ultracapacitors can be used.



ELECTRIC SHAG: A cross section of an electrode made with carbon nanotubes.



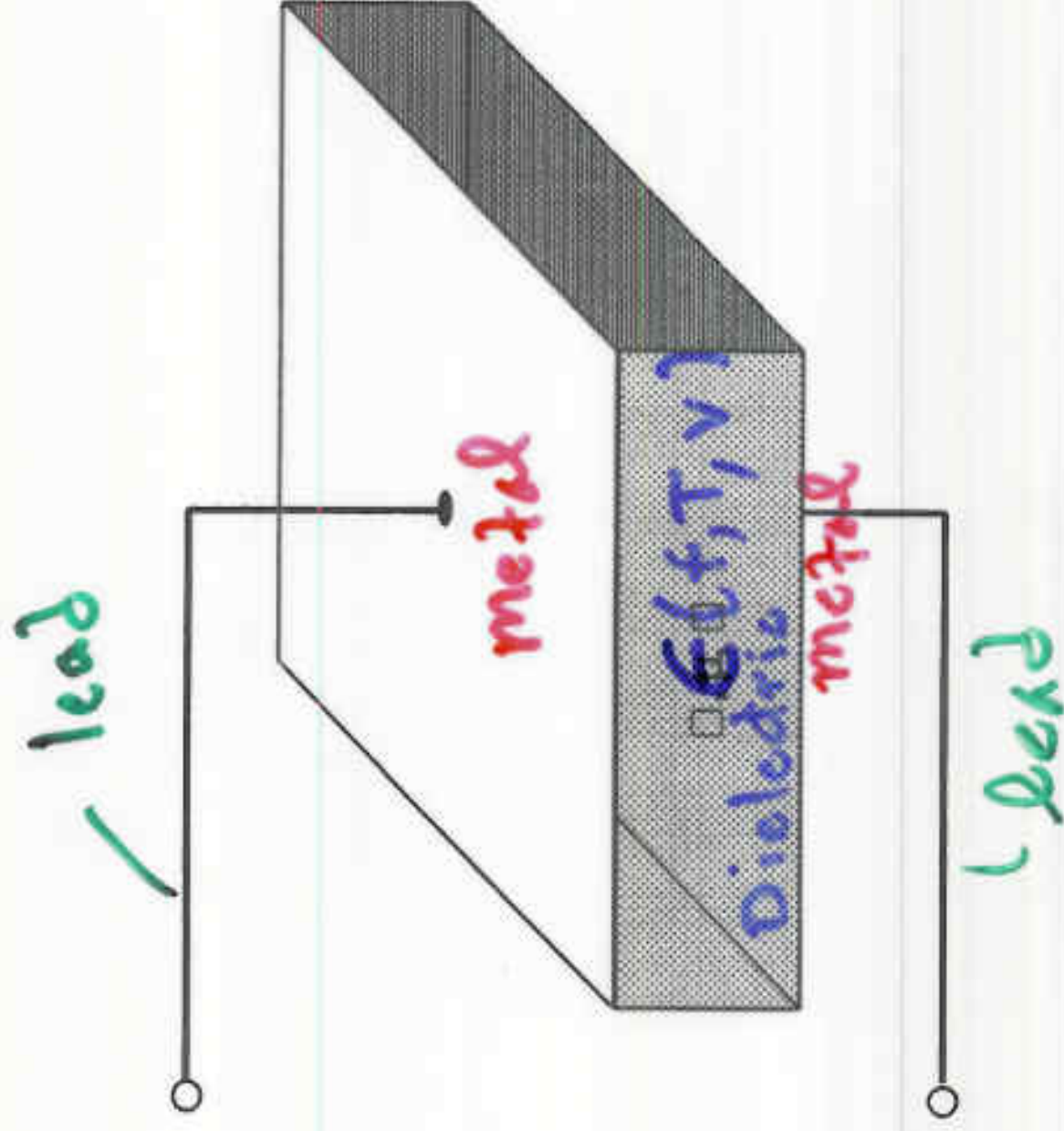


Figure 13. Generalized capacitor.



What do you get?

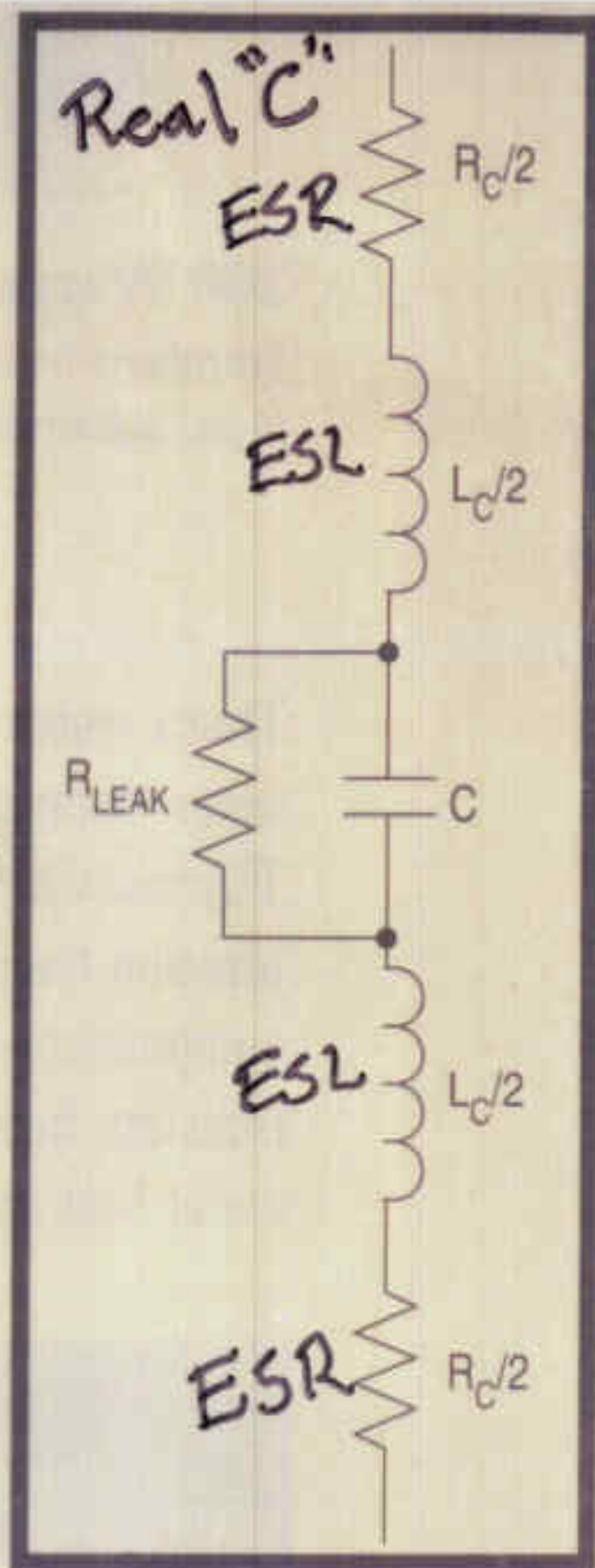


Fig. 2. Actual capacitors have parasitic inductance and resistance.

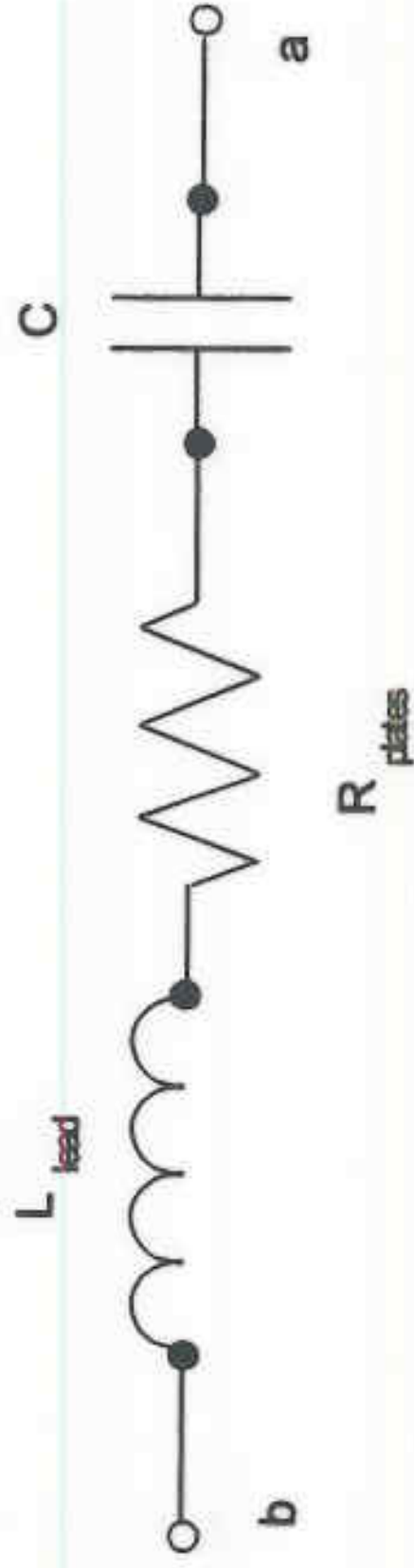
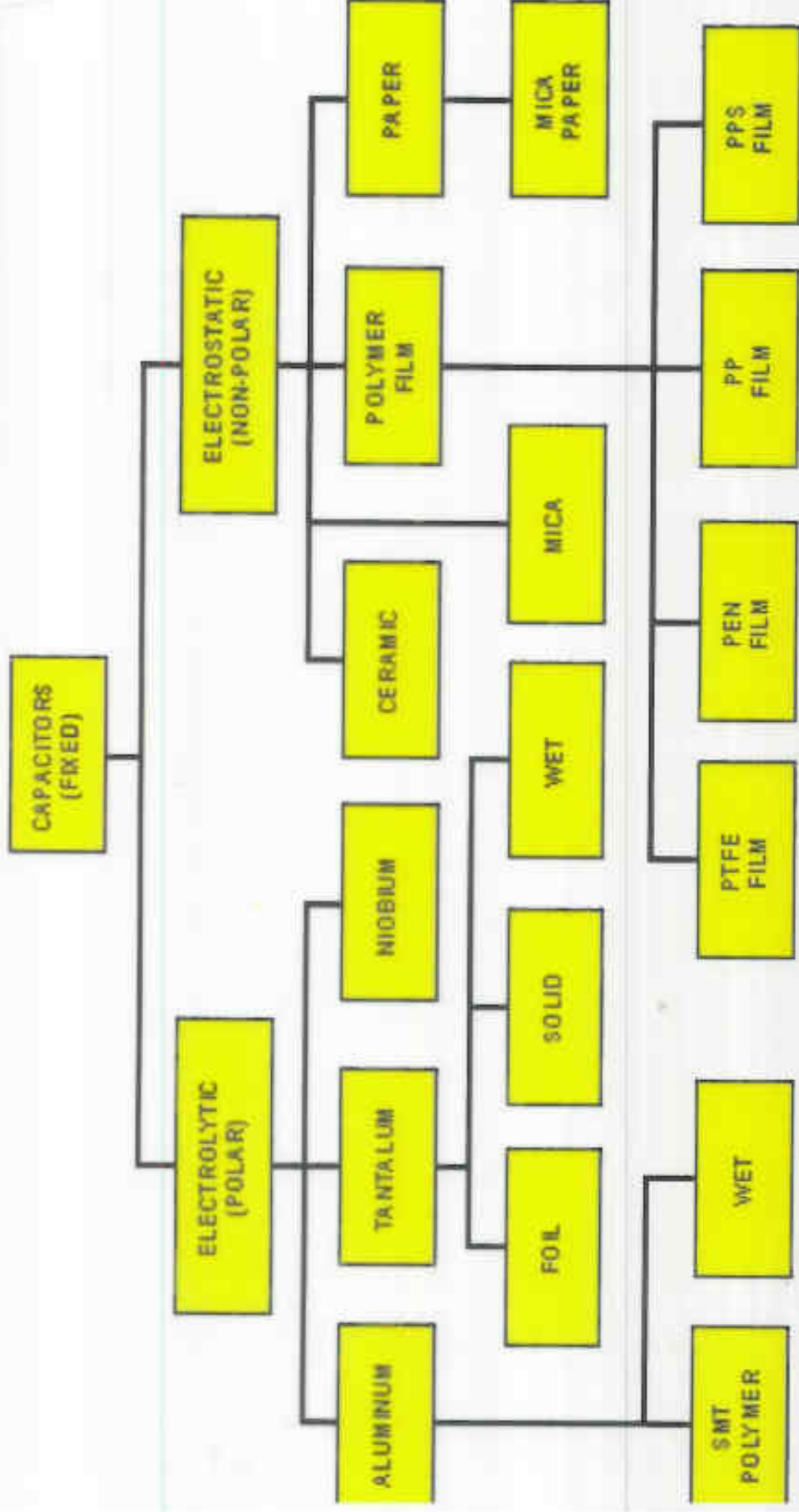


Figure 15. Simplified equivalent capacitor circuit.

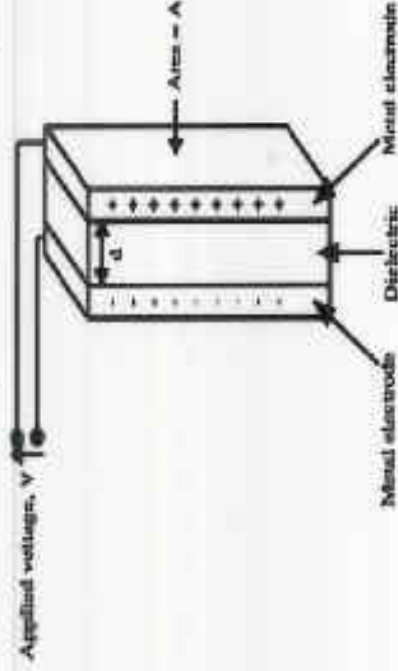
Capacitor Technologies



Vacuum Cap: High Q, high voltage

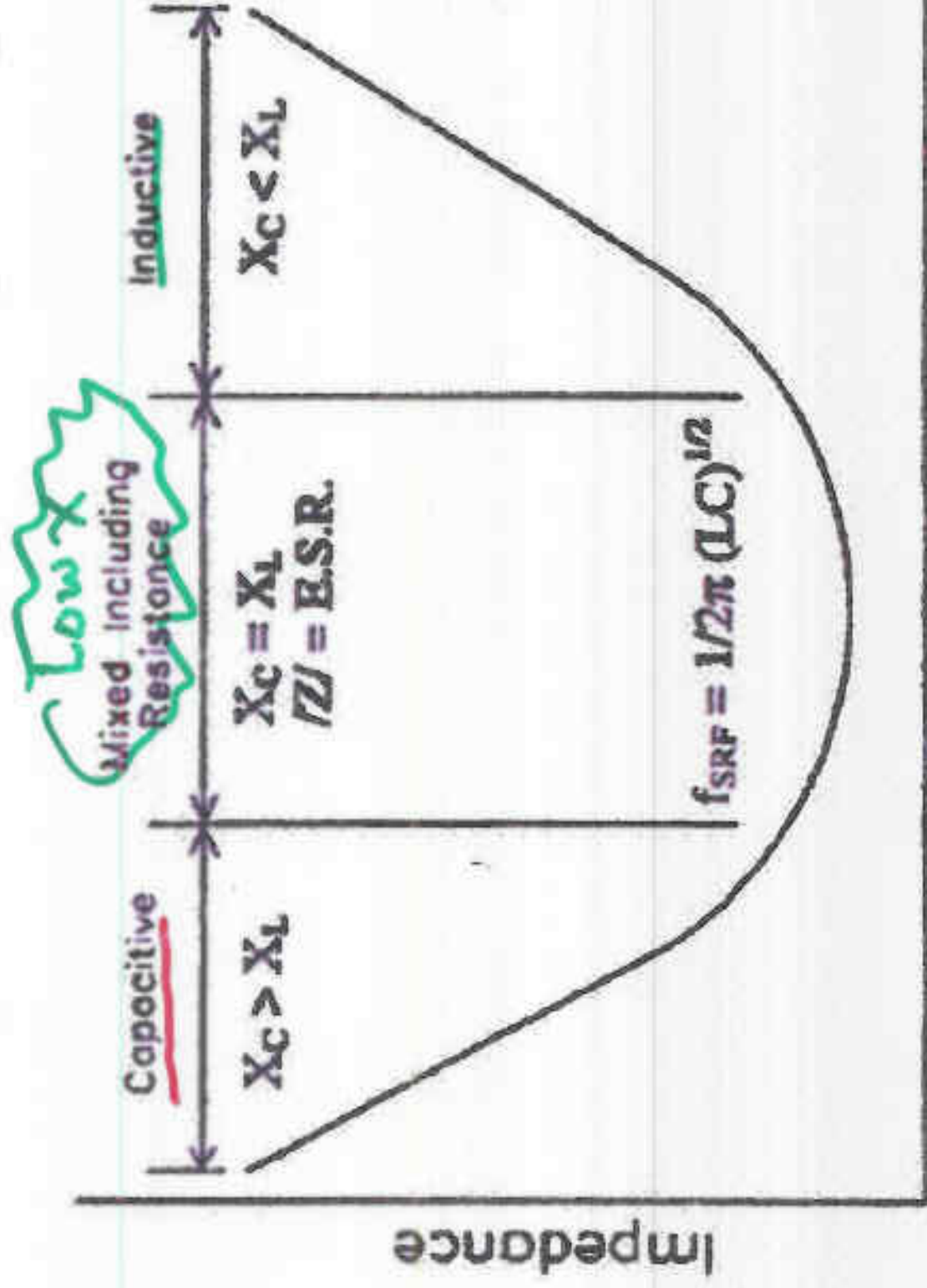
Capacitor Fundamentals

- In Conventional capacitors, capacitance is measured as the amount of charge divided by the voltage, and charge is proportional to area of the plates.
- Traditional capacitors require a large surface area plate to have more capacitance
- Ideally, to get a very large capacitance one wants a very large surface area with as little distance between the plates as possible



◆ Following graph illustrates how characteristic of some capacitors vary over frequency.

Impedance vs. Frequency



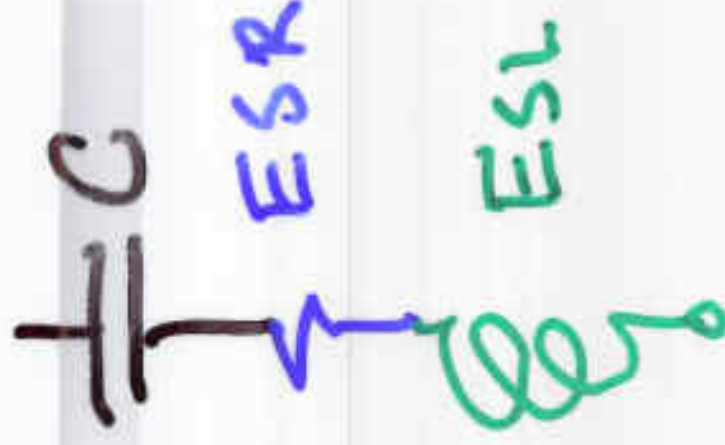
Frequency

ESR
 $R(f)$

Capacitance vs Frequency

The sheet resistance of the conductive plates of the capacitor and the wires that link these conductive plates to the terminals of the capacitors lead to a parasitic resistance that is called the ESR (Equivalent Series Resistance). The termination loop of the terminal wires also lead to a small and often negligible parasitic inductance called the ESL (Equivalent Series Inductance). Thus, the total impedance of a capacitor varies over the frequency at which it is used.

ESL small but
 $\propto \frac{1}{f} \uparrow$ as $f \uparrow$



nect small RF-bypass capacitors across

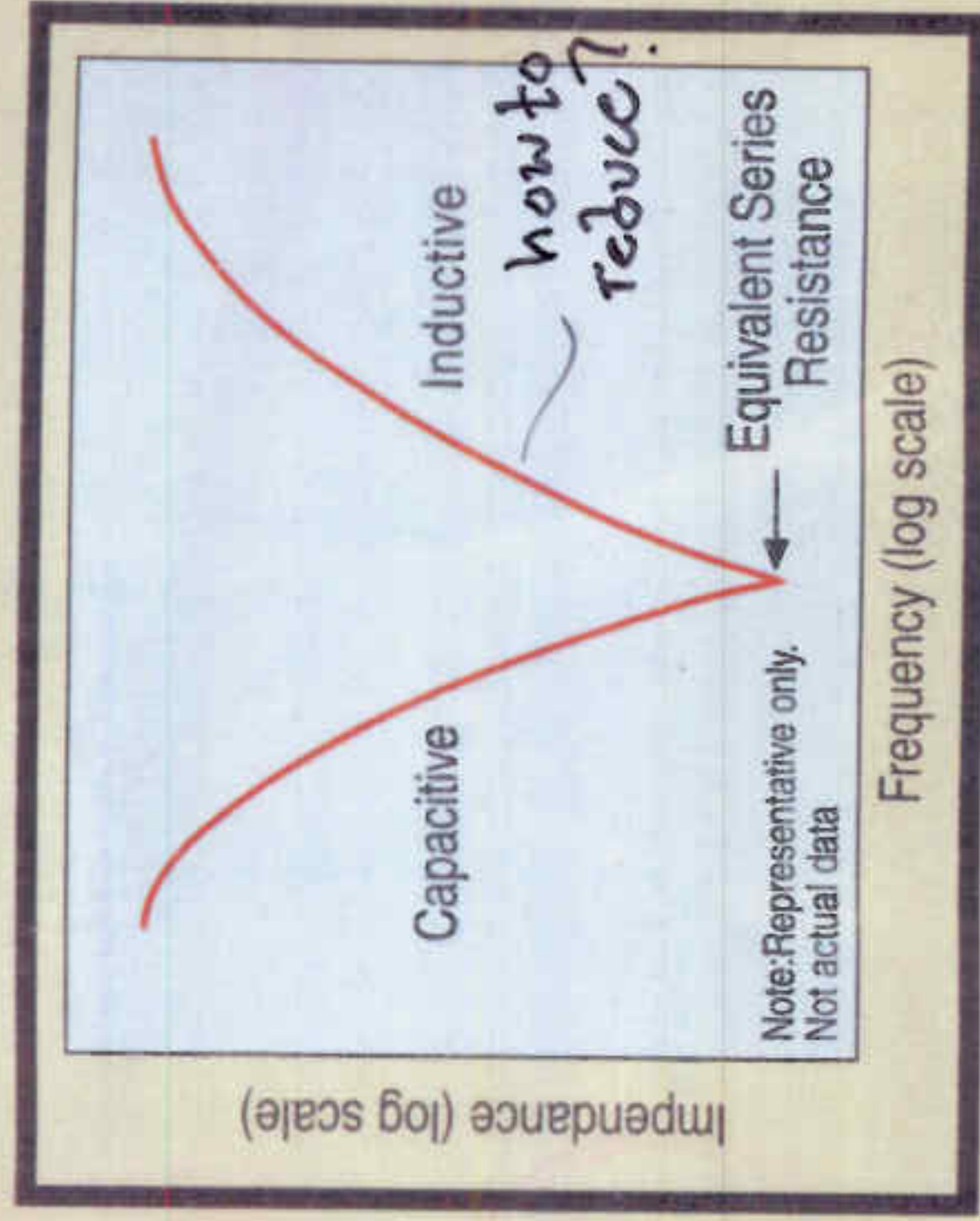


Fig. 3. As frequency increases, the parasitic inductance of a capacitor becomes dominant.

achieved in the last 10 years. With tantalum, the main ripple component comes from ESR.

$V_{in} = +5V$	$L = 8\mu H$ (10 μH nom))	$F = 650$ kHz
$V_{out} = +1.8V$	$t_{on} = 0.7\mu s$	$\Delta I_L = 0.24A$
$I_{out} = 600mA$	$t_{off} = 0.9\mu s$	$I_{peak} = 0.72A$

Nominal C	Minimum C	Dielectric	ΔV_c	ΔV_{esr}	ΔV_{esl}	ΔV_{out}
			$\Delta I_L / 8Cf$	$ESR \cdot \Delta I_L$	$ESL \cdot \Delta I_L \cdot (1/t_{on} + 1/t_{off})$	Graphic estimation
10 μF	7 μF	MK	6.5mV	2.6mV	0.4mV	$\approx 8mV$
22 μF	16 μF	MK	2.8mV	1.9mV	0.7mV	$\approx 5mV$
47 μF	34 μF	MK	1.4mV	1.4mV	0.7mV	$\approx 3mV$
33 μF	27 μF	TPA	1.7mV	17.7mV	3mV	$\approx 20mV$

Table 3. Ripple characteristics of output capacitor in a step-down converter.

Real $V_c(f)$

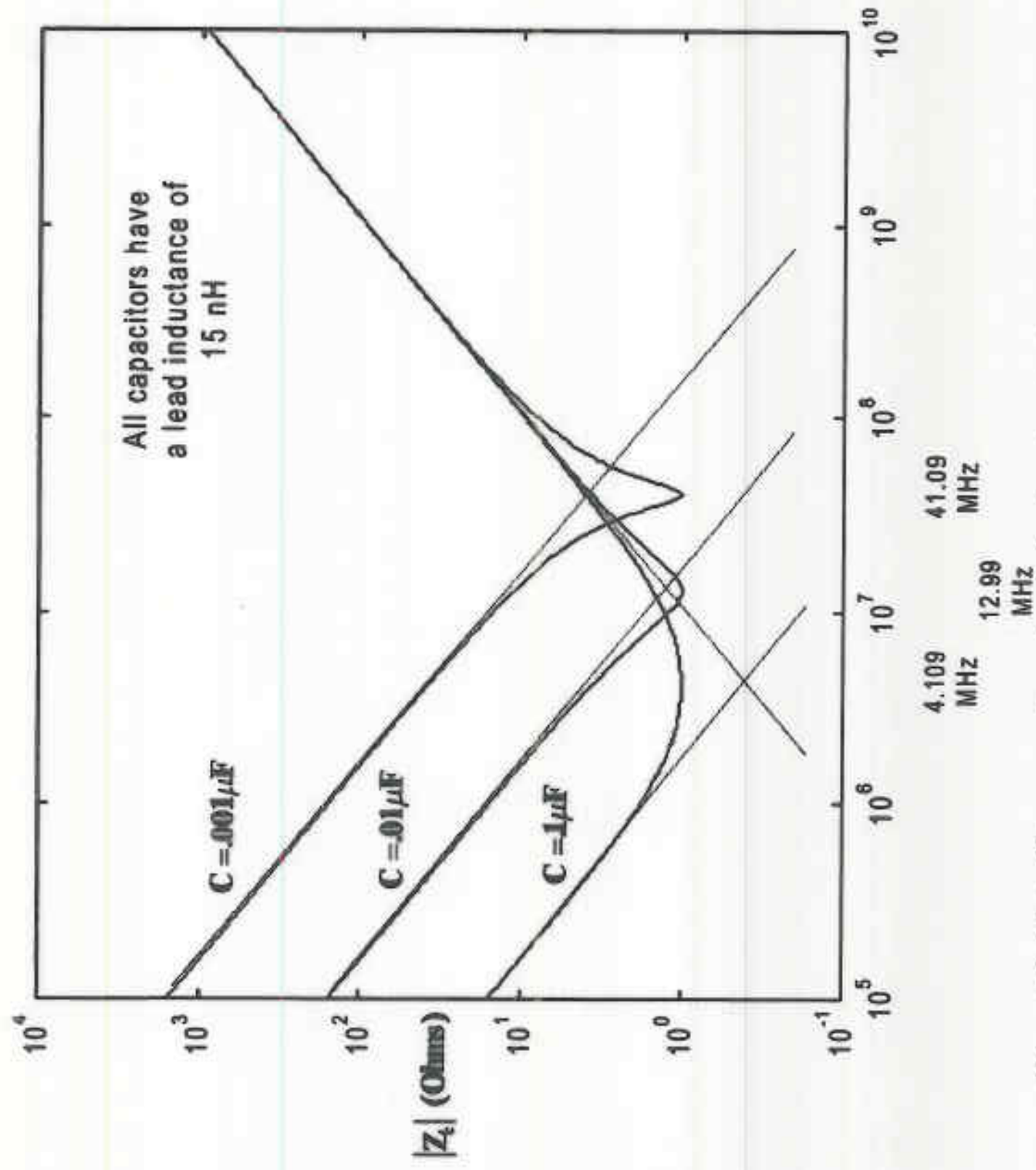


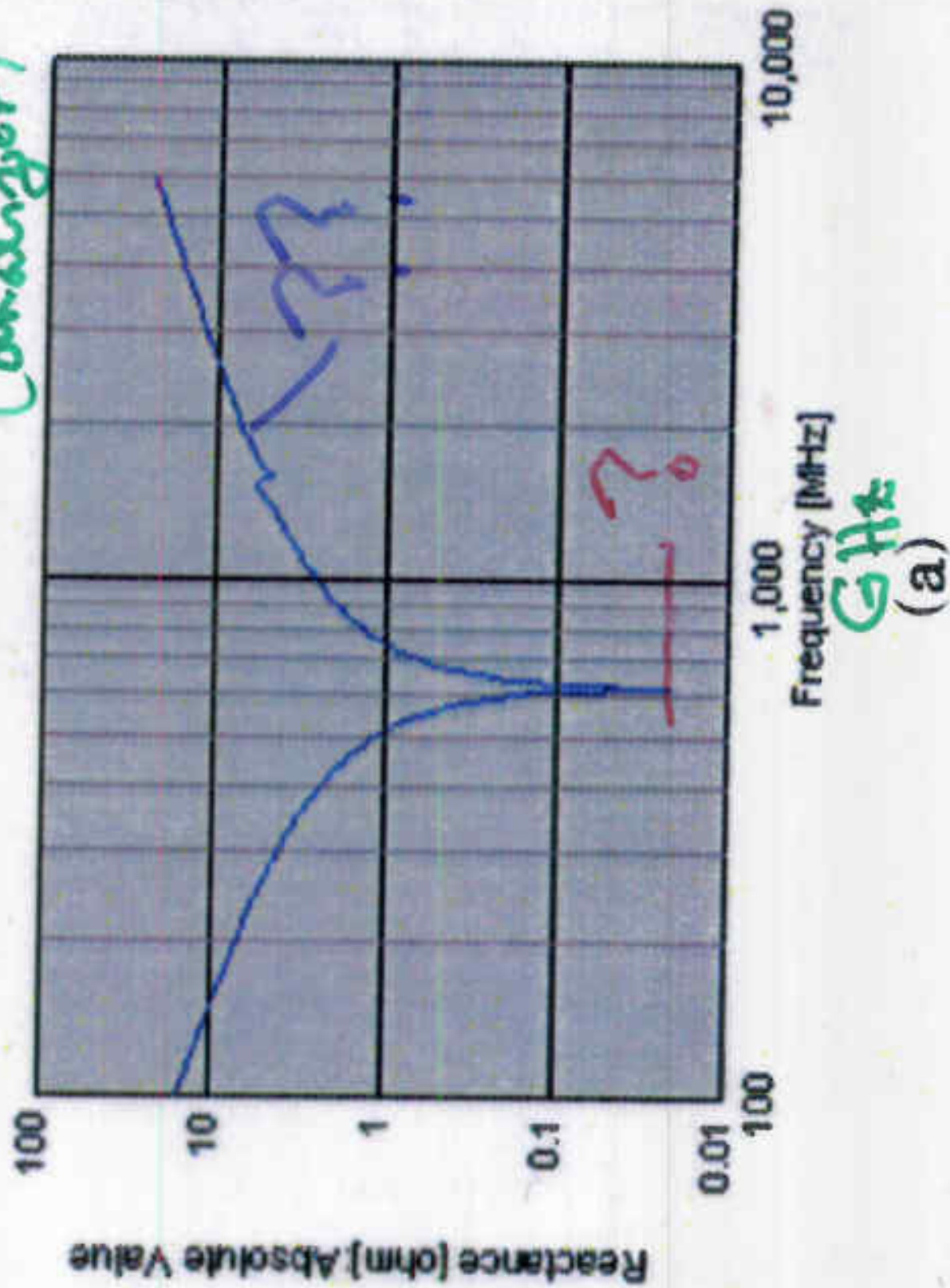
Figure 16: Plot of frequency dependent behavior of equivalent circuit for various capacitors.

- 07
- ◆ Most of the parasitic inductances that we are concerned with here are those associated with traces, bond-wires, lead terminations, etc. From an applications point of view, we need to be concerned about *PCB trace inductances* in particular --- for that is what we can minimize easily.
 - ◆ But not all PCB trace inductances are "trouble-makers". For example, the traces in series with the inductor are "benign" --- because they can be looked at as just being lumped together with the main inductor. A freewheeling path is available for them too --- the same as the freewheeling path of the main inductor.
 - ◆ However, certain other trace inductances do not have any freewheeling path, and will therefore "complain" --- in the form of voltage spikes across the board, as per the basic equation $V = L di/dt$. These traces are considered "high-frequency" or "critical traces" from the viewpoint of PCB layout, and their associated inductances are considered to be "uncoupled" or "leakage" inductances.





$Z_o(f)$ from a network analyzer



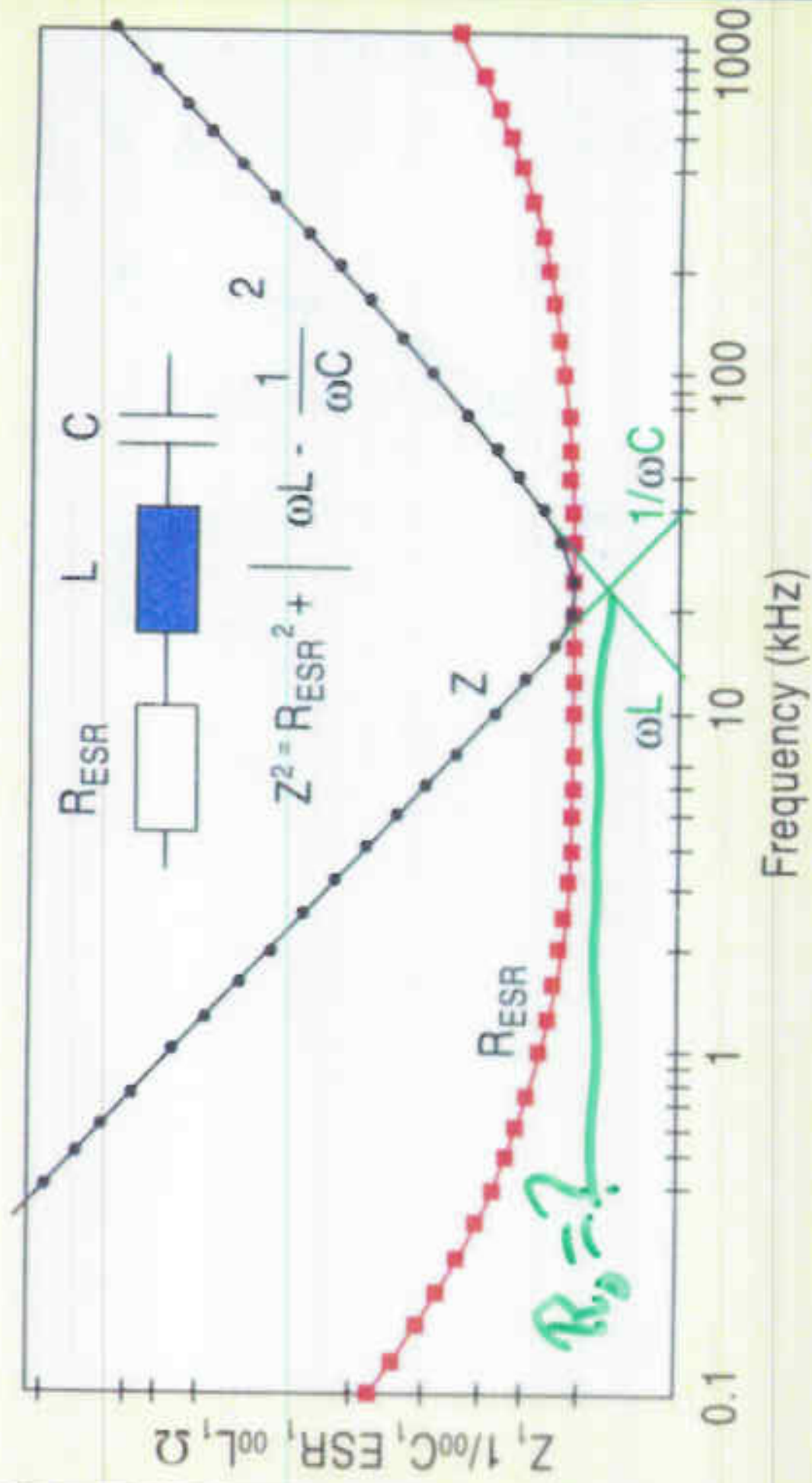


Fig. 5. Equivalent circuit, impedance and frequency dependence of bulk capacitors.

TAJB2226M010 vs. 1210ZD2226M (22 μ F/10V)

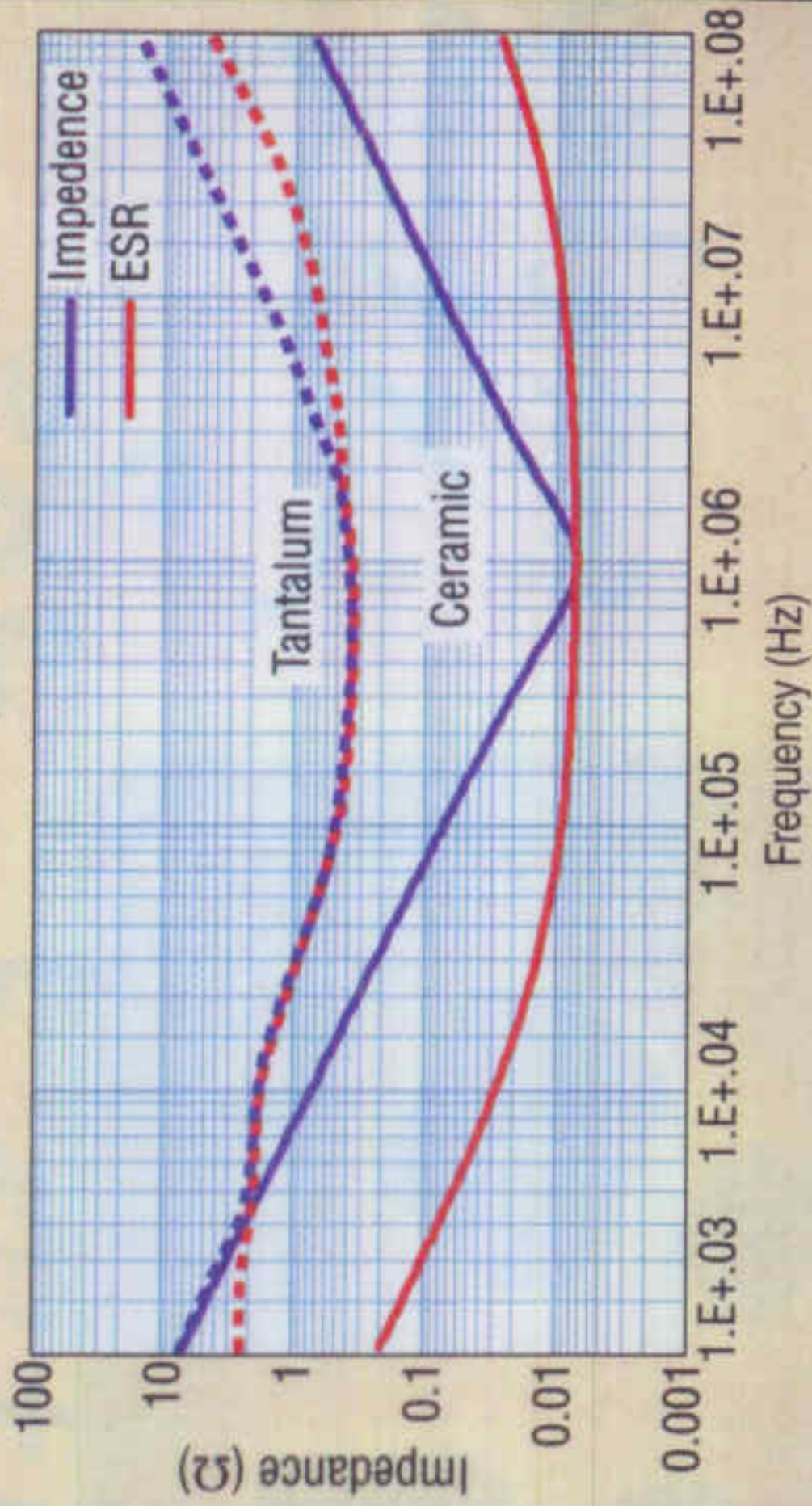
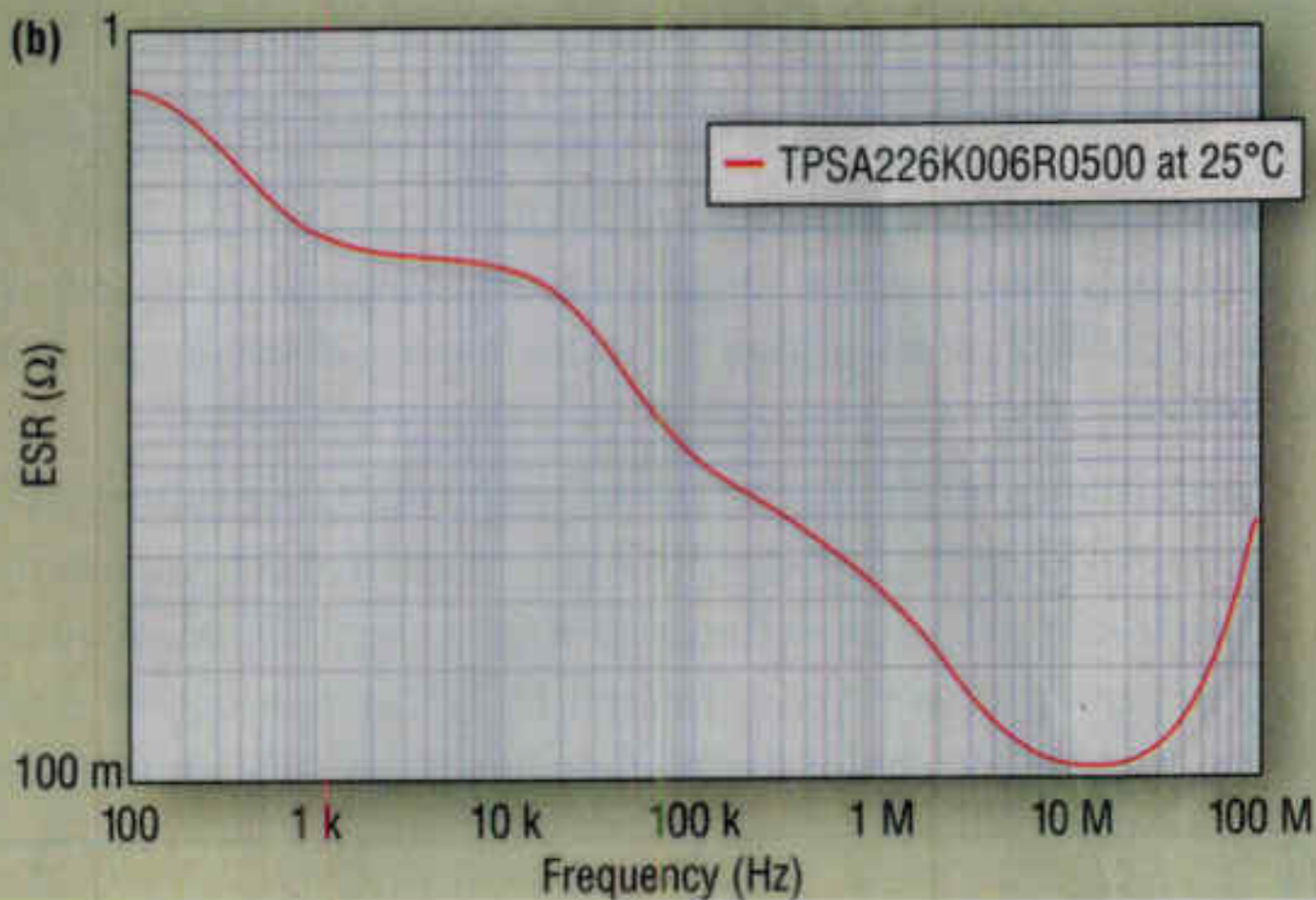
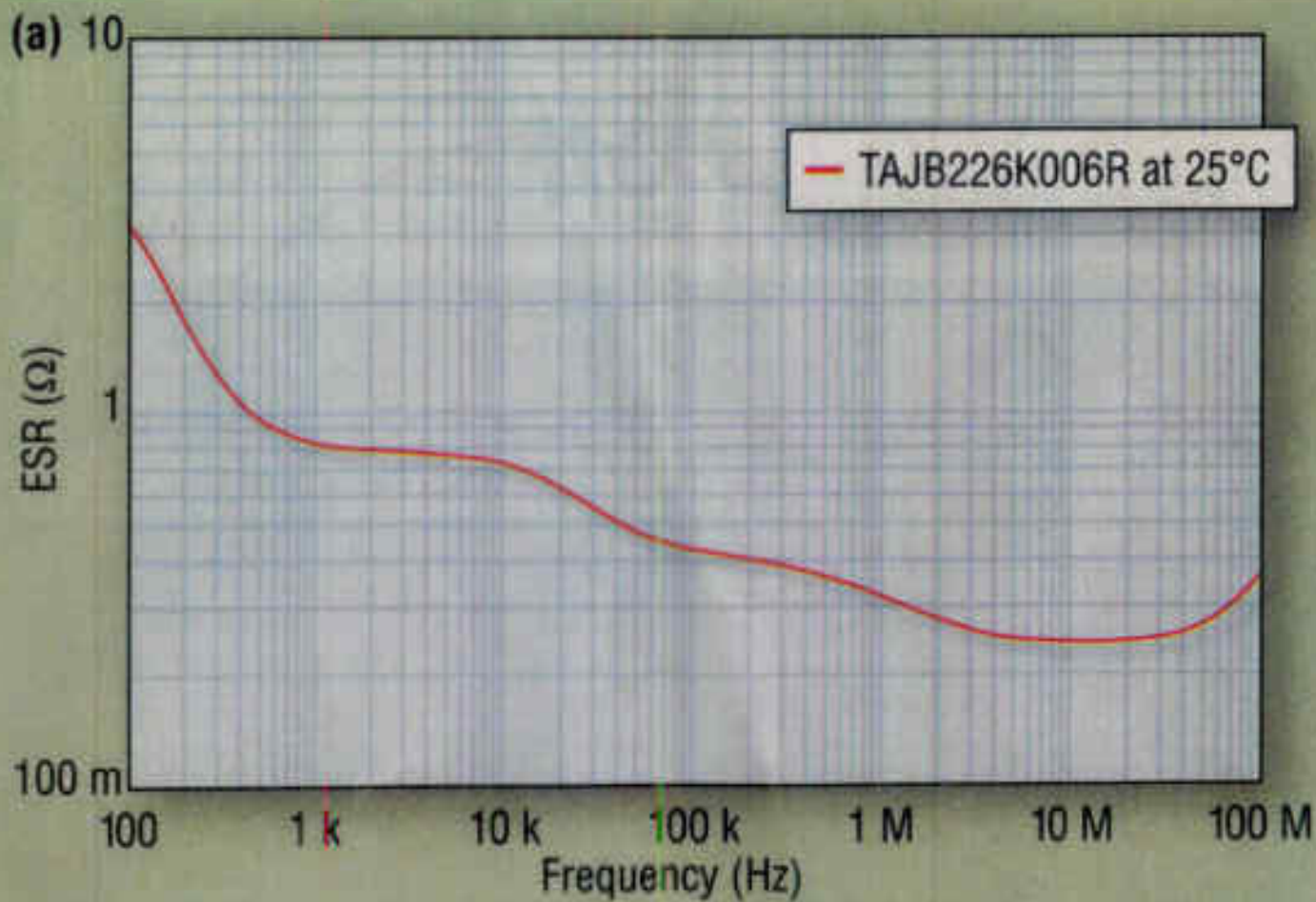


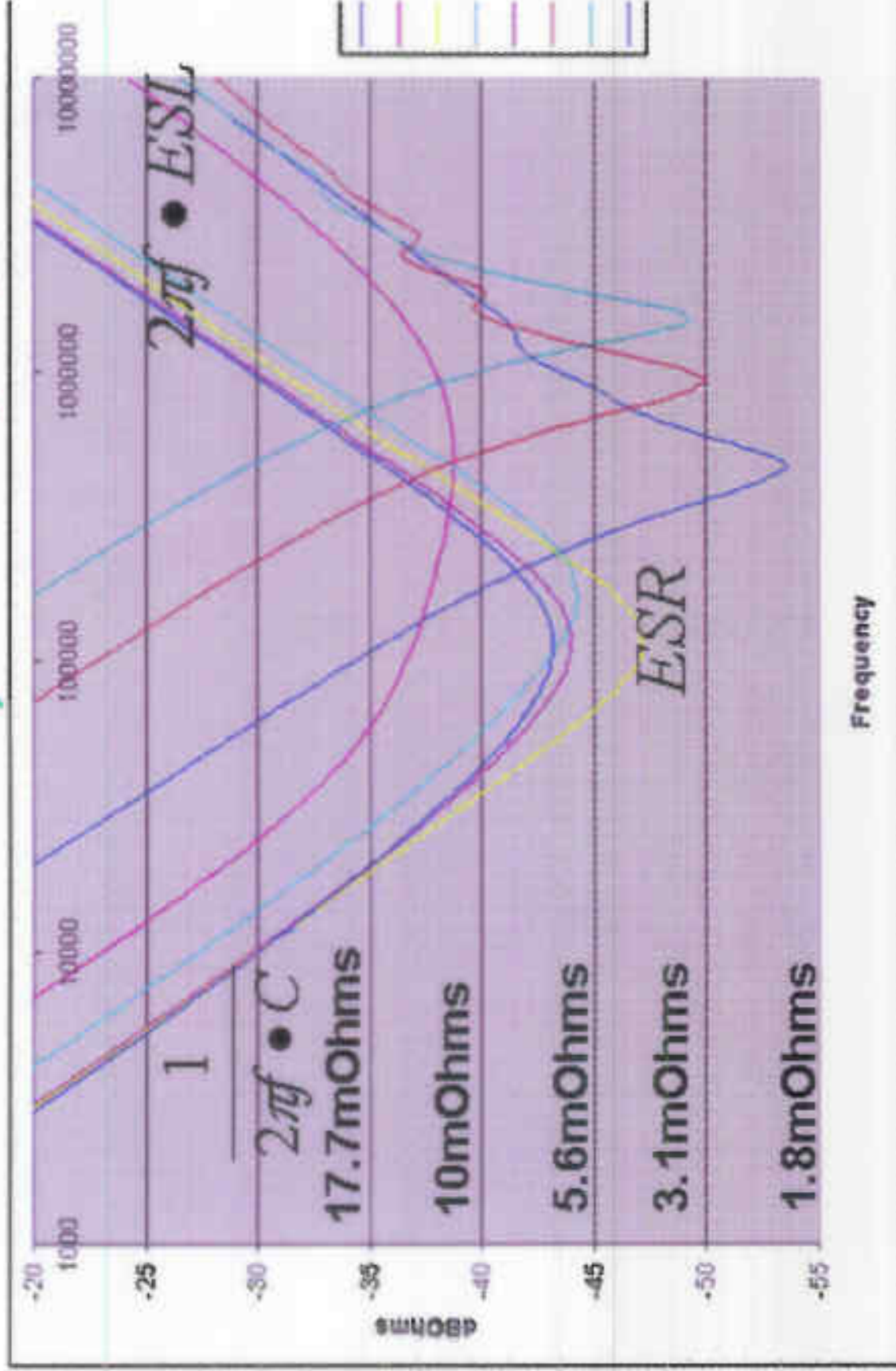
Fig. 1. Impedance versus frequency .

Technology	Capacitance Range (μF)	V_R Range (V)	ESR(min) (Ω)	Leakage $\text{nA} \times \mu\text{F} \times \text{V}$	Temperature Range ($^{\circ}\text{C}$)
Standard MnO_2	0.1 to 1000	4 to 50		10	-55 to +125
Low-ESR MnO_2	3.3 to 1000	4 to 50	0.1	10	-55 to +125
Standard 3f Multianode	330 to 1000	4 to 50	0.03	10	-55 to +125
Polymer	150 to 470	2.5 to 10	0.035	100	-55 to +105
Polymer Multianode	470 to 1000	2.5 to 6.3	0.01	100	-55 to +105

Capacitor characteristics.



Various C all show
ESL, ESR, f_r



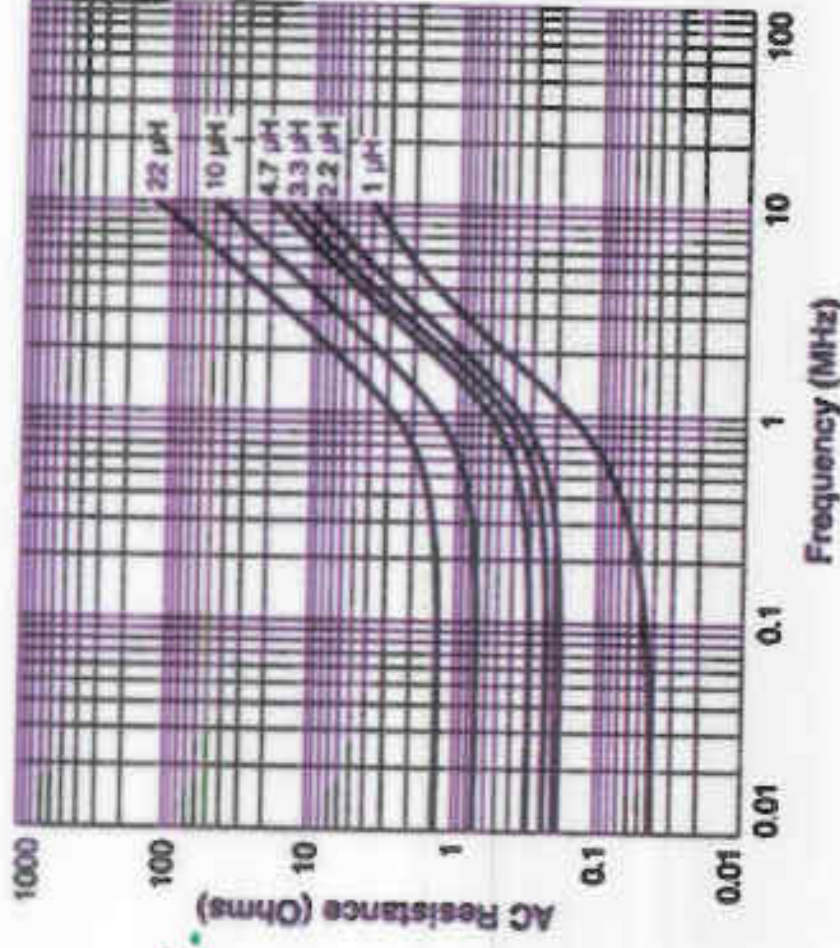
◆ Several factors affect the ESR:

- ◆ Thickness and material of the electrodes
- ◆ Area and aspect ratio of the electrodes
- ◆ Number of layers and parallel termination that form the electrodes
- ◆ Electrode surface flatness and metallization density
- ◆ Distributed resistance of the dielectric
- ◆ Frequency of operation

Below is a plot of ESR for various capacitors. Note that the ESR for ceramics can be as small as 1% of that of the Tantalum capacitors.

✦ Inherent to any conducting wire is an element of resistance. Also, the insulating material added around the wire, to prevent short circuit from one turn of the coil to another, acts as a dielectric that adds capacitance between the turns. So, each inductor comes with an inherent resistance and capacitance. In addition, at higher frequencies, current tends to flow closer to the conductor surface, an effect known as the skin effect. Thus, the total impedance offered by an inductor varies with voltage and frequency applied to it. An example inductor impedance vs frequency graph is shown below.

Typical AC Resistance vs Frequency



Wire $\rightarrow \epsilon$
insulation
needed to max.
 N^2

low f



rent is linear and equal to $\Delta I_L / t_{on}$:

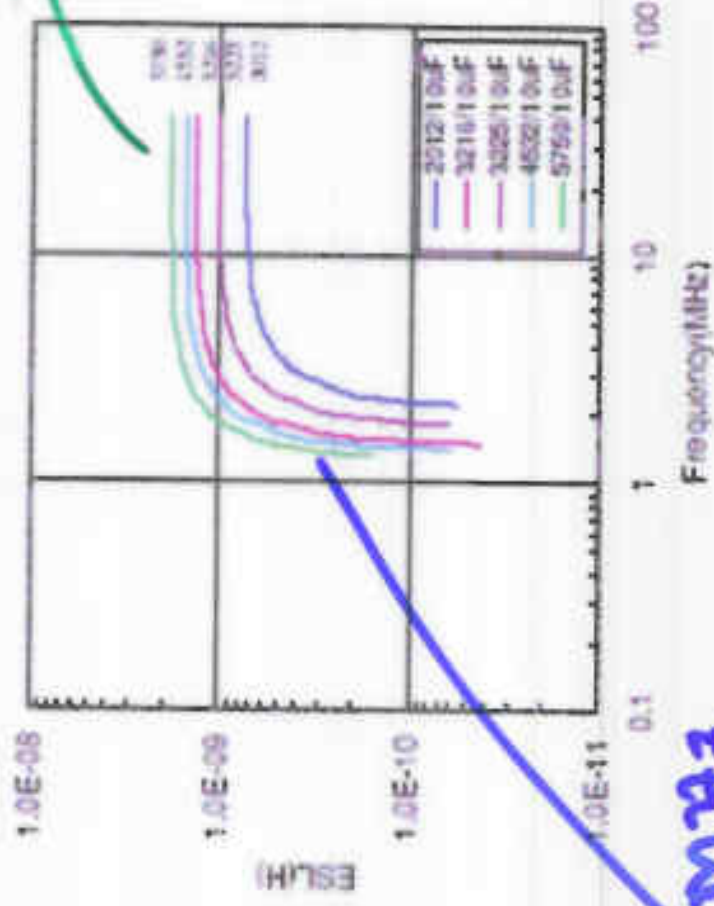
$$V_{esl} (0 < t < t_{on}) = ESL * \frac{\Delta I}{t_{on}}$$

$V_{in} = +5V$	$L = 8\mu H$ (10 μH nom)	$F = 650$ kHz
$V_{out} = +1.8V$	$t_{on} = 0.9\mu s$	$\Delta I_L = 0.24A$
$I_{out} = 600mA$	$t_{off} = 0.7\mu s$	$I_{peak} = 0.72A$

Nominal C	Minimum C	Dielectric	ΔV_c	ΔV_{esr}	ΔV_{esl}	ΔV_{out}
			$I_{out} * t_{off} / C$	$ESR * (I_{out} + \Delta I_L / 2)$	$ESL * \Delta I_L / t_{on}$	Graphic estimation
10 μF	7 μF	MK	77mV	7.9mV	0.2mV	$\approx 80mV$
22 μF	16 μF	MK	33.8mV	5.8mV	0.4mV	$\approx 36mV$
47 μF	34 μF	MK	15.9mV	4.3mV	0.4mV	$\approx 18mV$
33 μF	27 μF	TPA	20mV	54mV	1.7mV	$\approx 75mV$

Table 5. Ripple characteristics of input capacitor in a step-down converter.

- ◆ Area and aspect ratio of the electrodes
- ◆ Number of layers and parallel termination that form the electrodes
- ◆ Cover layer thickness
- ◆ Case size



$$14 f < 3 \text{ MHz}$$

$$ESL = f(f)$$

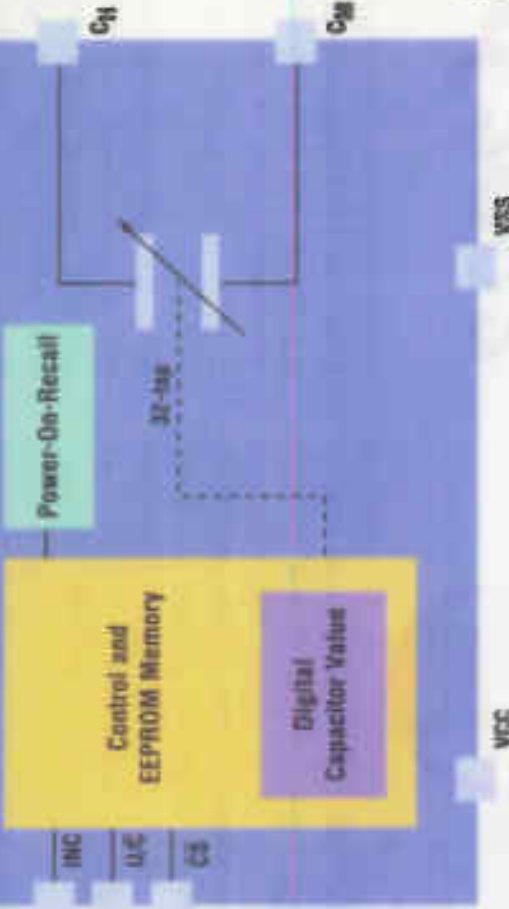
$$f > 3 \text{ MHz}$$

$$ESL \neq f(f)$$

Industry's First Non-Volatile Digitally Controlled Capacitor

Digital
up/down
Interface

Actual Size

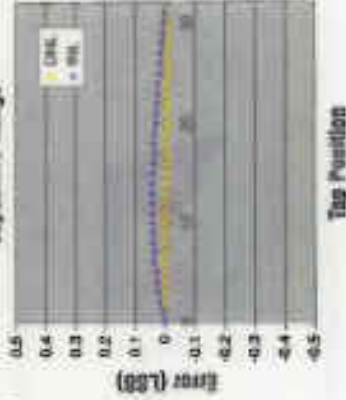


Features

- 32-tap Digital capacitor
- Non-volatile EEPROM Storage of capacitor value with Power-On-Recall
- Fast settling time of 5 μ sec

- Excellent Linearity
- Simple Digital interface to program & store
- X90100MB1: \$0.99 each in 10k units

Xicor X90100 Linearity Over Capacitive Range



Free Samples

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Product Information

www.xicor.com/X90100

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Xicor, Inc. 933 Murphy Ranch Rd
Milpitas, CA 95035-7493
Call: (408) 432-8888

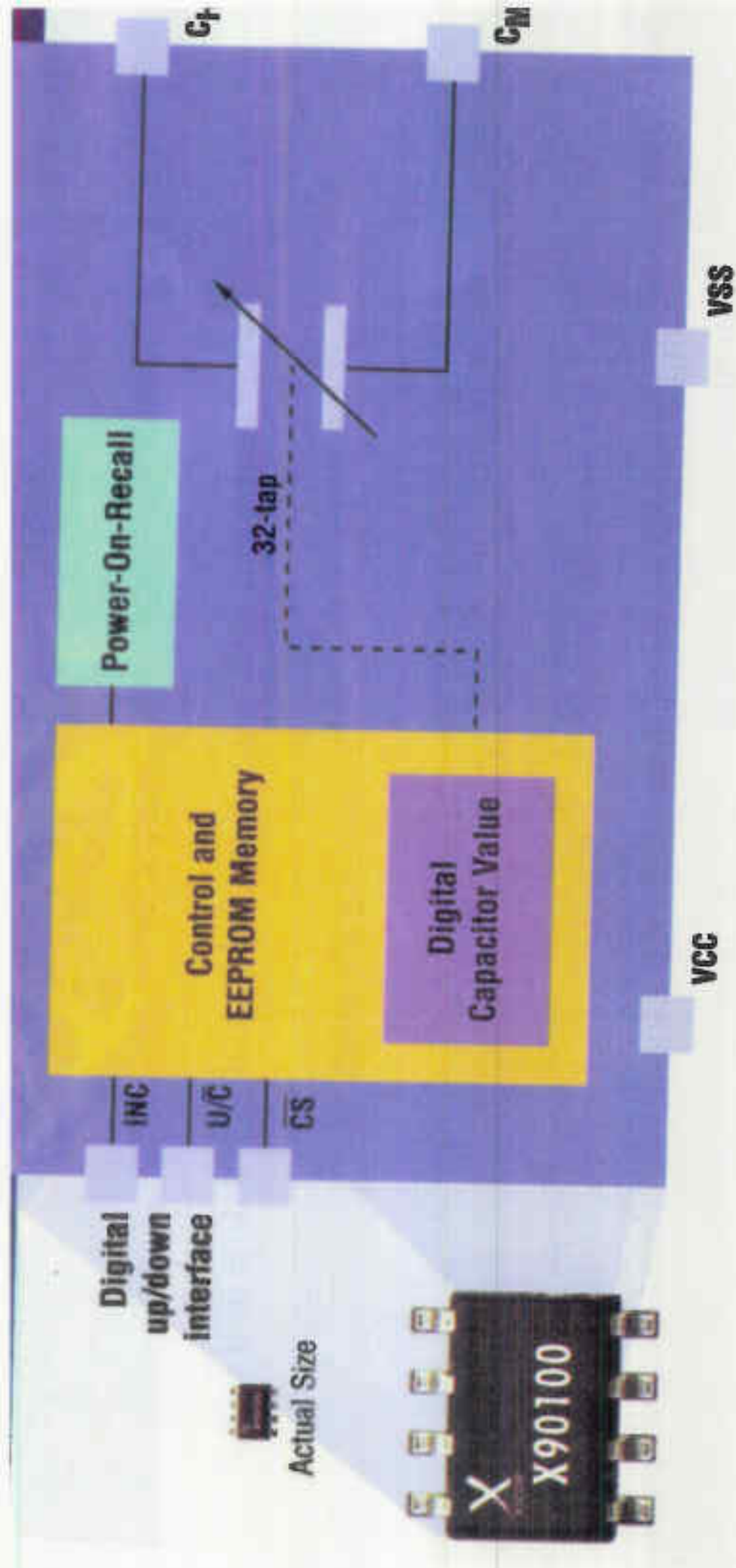
X90100 Replaces variable capacitors used to tune the frequency response of electronic systems up to 400MHz

The Digitally Controlled Capacitor can be set to 1 of 32 discrete steps ranging from 7.5 pF to 14.5 pF in 0.20 pF increments. Once the desired capacitor value is selected via an UP/DOWN interface, it is stored in the on-chip EEPROM. The chip also has an integrated Power-On-Recall circuit that will restore the preset capacitor position from the EEPROM during power up, thus eliminating the need of microcontroller initialization. As a result, the X90100 reduces the cost of components and manufacturing.



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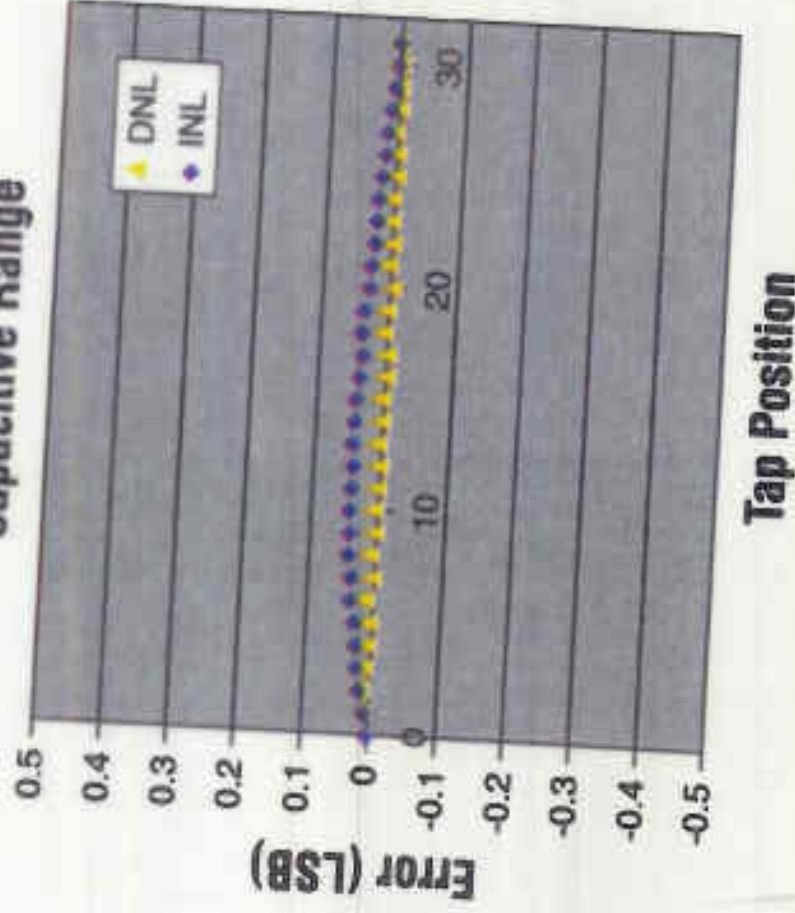


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Features

- 32-tap Digital capacitor
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- Simple Digital interface to program & store
- X90100M8I: \$0.99 each in 10k units

Xicor X90100 Linearity Over Capacitive Range



Free Samples

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